



HEAD OF DELEGATION (HoD) REPORT

U.S. Member Body of the
International Organization for
Standardization (ISO)



U.S. National Committee of the
International Electrotechnical
Commission (IEC)

Please return this report within one month of the completion of the international meeting and submit it to the appropriate ANSI Department as follows:

ISO

USNC

ISOT@ansi.org

USNC@ansi.org

HoD reports can be used for a variety of purposes. For example:

- ❖ To report results of a TC/SC meeting to the related TAG
- ❖ To publicize the work of the TC/SC to the related US constituency via ANSI On-line, USNC News and Notes, or other media
- ❖ To suggest areas for possible development of featured articles
- ❖ To address specific challenges and concerns that the HoD may bring to the attention of related ANSI and/or USNC/IEC management

PLEASE REMEMBER: Your HoD report is NOT filed as a confidential, password protected document and, therefore, may have broad, unintended distribution. Keep this in mind when preparing the report and, if appropriate, use a more secure form of correspondence to call attention to any sensitive issues.

Completed by:

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Date:	2016-10-21

Meeting of TC86 (Designation/Title) Fibre Optics
Date(s) 2016-10-13
Location Frankfurt, Germany

1. MEETING ATTENDANCE
<p>Please indicate, if available, both the number of delegates and the countries represented at the Meeting:</p> <p>There were 17 delegates from 8 P-member countries (Canada, China, France, Germany, Italy, Japan, Korea & USA), 2 liaisons, one observer from China, and one observer from Malaysia (neither P nor O-member of SC86C). The Chair, Secretary, Assistant Secretary and TO brought total attendance to 25.</p> <p><input type="checkbox"/> Meeting attendance roster and meeting resolutions attached, if available</p> <p>Please comment on significant or unusual attendance issues (e.g., new member bodies, regular members not in attendance, new Chairman or Secretariat, non-accredited U.S. persons, etc.).</p>
MEETING OBSERVATIONS
2. Overall, how well did the U.S. meet its objectives on policy or technical matters?
<p><input checked="" type="checkbox"/> Very Successful -- U.S. positions were accepted in whole <input type="checkbox"/> Successful -- Compromises were reached which are acceptable to the U.S. <input type="checkbox"/> Not Successful -- U.S. positions were not accepted</p>
3. Please comment on any issues of significance which might have an impact upon materially affected or interested U.S. parties.
<p>There is a new initiative in TC86 and SC86C in the area of Photonics Integrated Circuits (PICs). There are many active members from Europe and Asia, but none from the US. There is significant activity in PIC in the US so we need to figure out how to attract experts into the standardization activities.</p>
4. Was there any discussion for which the United States was unprepared? (e.g., late document distribution, addition of new items, etc.)
<p>No</p>
5. Did the U.S. extend an offer to assume any new TC/SC Secretariat or management positions?
<p><input type="checkbox"/> Yes <input checked="" type="checkbox"/> No (If yes, please indicate which position and provide Officer contact information.)</p>
6. Did the U.S. extend an offer to host any future TC/SC meetings?
<p><input type="checkbox"/> Yes <input checked="" type="checkbox"/> No If yes, please identify:</p>

7.	Were any new issues raised which require, or might involve, coordination with other U.S. bodies? (Include coordination items with other U.S. TAGs, ANSI policy-level committees (AIF, AIC, the USNC TMC and/or Council, etc.)
	<input checked="" type="checkbox"/> Yes ___ No If yes, please identify: Perhaps in the recruitment of US experts in the area of Photonics Integrated Circuits.
8.	Did the U.S. put forth/agree to put forth any New Work Items?
	___ Yes <input checked="" type="checkbox"/> No If yes, please identify:
9.	Was there any evidence of irregular voting by participating countries?
	___ Yes <input checked="" type="checkbox"/> No If yes, please identify any significant issues or concerns:
10.	Are work items in the TC or SC being affected by related work in regional standards bodies (e.g., CEN, CENELEC, ETSI, PASC, NAFTA, COPANT, etc.)?
	___ Yes <input checked="" type="checkbox"/> No ___ No related regional activity If yes, please explain:
11.	Were any new issues raised which require, or might involve, coordination with emerging market countries?
	___ Yes <input checked="" type="checkbox"/> No If yes, please explain:
12.	Were any issues raised which relate to or impact existing U.S. regulatory matters?
	___ Yes <input checked="" type="checkbox"/> No If yes, please explain:
13.	Please identify any IMMEDIATE U.S. TAG actions which will be required as a result of this international meeting.
	None

14.	Please identify specific decisions which the U.S. delegation believes to be noteworthy for publication, publicity and/or development of a future article. If there are any, would you be willing to help develop an article for publication?
	<input type="checkbox"/> Yes <input checked="" type="checkbox"/> No
15.	What might be done to further promote the ANSI Federation's goal of "global standards that reflect U.S. interests?" (Consider such issues as how might the U.S. further promote acceptance of related American National Standards in international and, where applicable, regional fora?)
16.	Has this report been provided to your TAG Administrator for US TAG distribution?
	<input type="checkbox"/> Yes <input type="checkbox"/> No
17.	Do you have any questions, comments, or suggestions regarding the ISO/IEC Directives, including the IEC Supplement? <hr/> <hr/> <hr/>
18.	Other Comments

May 2016